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Band alignment of orthorhombic Ga₂O₃ with GaN and AlN semiconductorsShibin Krishna^{*}, Yi Lu, Che-Hao Liao, Vishal Khandelwal, Xiaohang Li^{*}

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ABSTRACT

Ga₂O₃ semiconductors have attracted tremendous research interests because of their fascinating material properties for future-generation energy, electronic, and optoelectronic applications. In the present study, we have performed the epitaxial growth of tin-doped Ga₂O₃ on sapphire, GaN, and AlN templates by the pulsed laser deposition technique. The initial characterizations show a two-dimensional mode of single-crystalline orthorhombic Ga₂O₃ (κ -Ga₂O₃) growth on these substrates with smooth surface morphology. Integrating κ -Ga₂O₃ with nitride semiconductors is interesting since both these materials possess polarization, which could induce 2-dimensional carrier gas (2DCG) at the interface. X-ray photoelectron spectroscopy studies reveal that both κ -Ga₂O₃/GaN and κ -Ga₂O₃/AlN heterostructure form a type-I band structure where the conduction band offset (CBO) was calculated to be 1.38 eV and 1.04 eV, respectively. This unique band alignment with high CBO could lead to the development of efficient power devices.

1. Introduction

Power device technology plays a central role in numerous crucial applications, including electric vehicles, solar farms, 5G/6G, and data centers [1–3]. GaN and AlN are promising wide bandgap (WBG) semiconductors that lead to power devices which operate with considerably higher voltage and efficiency than conventional silicon with smaller bandgap and breakdown field [4]. With decades of development, nitride-based power devices have entered wide market adoption. However, despite that the Ga₂O₃ ultra-wide bandgap (UWBG) semiconductor possesses an even greater Baliga figure of merit [5], the research and commercialization of Ga₂O₃-based power devices are still at the relatively early stage due to some serious issues such as a lack of effective p-doping techniques and poor thermal conductivity [4].

There are mainly different polymorphs for Ga₂O₃, comprising corundum (α), monoclinic (β), defective spinel (γ), cubic (δ), hexagonal (ϵ), and orthorhombic (κ) phase [6]. One of the polymorphs of Ga₂O₃, β -Ga₂O₃, has been well explored concerning the growth, material properties, and devices because of its high thermal stability [7–9]. However, the other polymorph of Ga₂O₃ are still behind as most of them are in a metastable state and change to a stable β phase at higher temperatures (>500 °C) [10]. Interestingly, in the orthorhombic phase, one of the metastable phases of Ga₂O₃, represented as κ -Ga₂O₃, shows spontaneous polarization [11,12] and high-temperature stability till 1000 °C [13]. Lately, κ -Ga₂O₃ has captivated huge research attention due

to the predicted high value of its spontaneous polarization i.e., 0.23 C/m² [14,15]. Therefore, this promising property can effectively control the two-dimensional carrier gas (2DCG) at the interfaces between κ -Ga₂O₃ and other suitable semiconductors without any chemical impurity doping. Hence, integrating high polarisation semiconductors such as nitride (spontaneous polarization of AlN = 1.33 C/m; GaN = 1.33 C/m) [16] with κ -Ga₂O₃ semiconductors can lead to huge polarization difference which opens a prospect to control the interfacial conductivity similar to an AlGaN/GaN heterostructure [17,18]. Furthermore, as compared to nitride semiconductors, the κ -Ga₂O₃ phase could show not only the polarization but also the ferroelectric property. This suggests that the spontaneous polarization of κ -Ga₂O₃ could be changed by applying an external electric field [19].

Therefore, integrating existing nitride technology with κ -Ga₂O₃ semiconductors can provide a favorable platform for exploring emerging phenomena, which motivates new concepts for fundamental physics and applied research. Moreover, this combination can effectively alleviate the thermal issue of κ -Ga₂O₃. Thereby, fundamental properties of κ -Ga₂O₃ based heterostructures, such as the energy band diagram, band alignment, built-in interface potential, and polarity discontinuity, are crucial for the tuning of polar oxide interfaces toward advanced devices [20]. We have previously studied the band alignment of β -Ga₂O₃ and AlN, and a type-II heterostructure has been witnessed [21]. In this work, the study of valence and conduction band offsets (VBO and CBO) of κ -Ga₂O₃/GaN and κ -Ga₂O₃/AlN heterojunctions have been calculated

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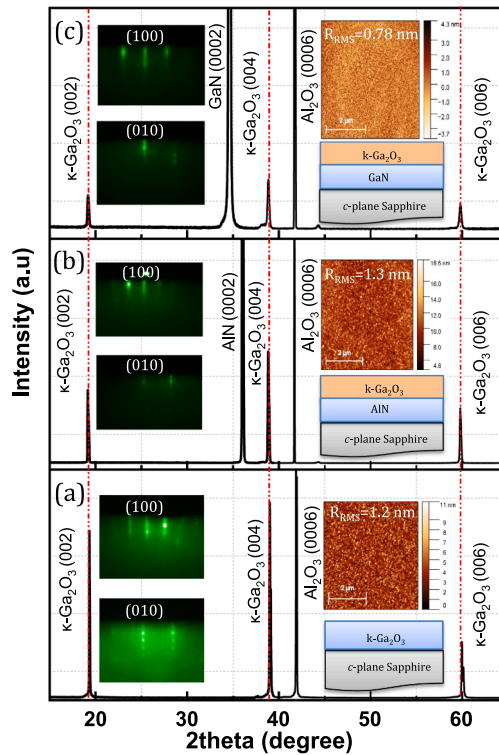


Fig. 1. XRD 2theta-omega scan profiles of κ -Ga₂O₃ layers grown on (a) c-plane Sapphire (0001), (b) AlN (0001), and (c) GaN (0001). The left inset represents the RHEED images along (100) and (010) azimuthal planes where a two-dimensional film growth was witnessed. The right insets show the corresponding AFM image and schematic of the growth structure.

experimentally and type-I band alignments for both combinations are confirmed. The band offset of κ -Ga₂O₃/nitride heterostructure is extremely important because it ascertains the energy barriers in electron and hole transport for the efficient working of electronic and optical devices.

2. Experimental section

In this work, we perform the pulsed laser deposition (PLD) technique for the growth of κ -Ga₂O₃ on sapphire, GaN, and AlN templates. The 3

μ m epitaxial GaN and AlN growths were carried out in a Taiyo Nippon Sanso SR-4000HT horizontal Metal Organic Chemical Vapor Deposition (MOCVD) system on a c-plane sapphire substrate. Trimethylaluminum (TMA), trimethylgallium (TMG), and ammonia (NH₃) were used as precursors with nitrogen (N₂) as the carrier gas. The substrate growth temperature is 1340°C and 1150°C while V/III ratio is 742 and 2423 for AlN and GaN growth respectively. Prior to the PLD deposition, the sapphire substrate, MOCVD grown GaN and AlN templates were cleaned ultrasonically with acetone (5 min) followed by isopropyl alcohol (5 min) and then rinsed with deionized water. The tin doped (1.5 wt%) Ga₂O₃ target was irradiated using a KrF excimer laser ($\lambda = 248$ nm) at 100 mJ (on the target) for 15,000 pulses at a frequency of 2 Hz for bulk samples with a thickness of 360 nm. Further, 3 nm thick κ -Ga₂O₃ was grown on GaN and AlN template for high-resolution X-ray photoemission spectroscopy (HR-XPS) heterointerface analysis. The growth was performed at a substrate temperature of 650°C without the presence of oxygen partial pressure (chamber vacuum: 6×10^{-7} Torr). The crystal quality of the PLD grown κ -Ga₂O₃ on the various substrates has been analyzed by X-Ray diffractometer (XRD) and high-resolution scanning transmission electron microscopy (HR-STEM).

3. Results and discussion

Fig. 1 shows the XRD 2theta-omega scan profiles of κ -Ga₂O₃ layers directly grown on (a) c-plane Sapphire (0001), (b) AlN (0001), and (c) GaN (0001) substrates. κ -Ga₂O₃ films were grown along (001) direction for all the substrates where the 2theta angle positioned at 19.15°, 38.80°, and 59.75° represents the (002), (004) and (006) plane of diffraction of κ -Ga₂O₃. The 2theta scan is also represented in logarithmic scale to see each reflection in detail ([supplementary information S1](#)). The sharp and intense X-Ray diffraction peaks of κ -Ga₂O₃ divulge the single crystalline hetero-epitaxial growth on sapphire, GaN, and AlN templates. Further, 2theta positions perceived at 34.5° and 36° belong to GaN and AlN, respectively. All the XRD peak positions are calibrated with a sapphire substrate peak at 41.6°. To confirm the orthorhombic phase of Ga₂O₃, ϕ scan for a 2θ value of 33.05° and a χ value of 54.67° is performed ([supplementary information S1](#)). At this particular angle, only (122) reflex of the orthorhombic lattice can be observed [22,23]. The 12 peaks correspond to three rotation domains of orthorhombic κ -Ga₂O₃ which are not overlapping in direction with the ones of other domains. The epitaxial relationship between κ -Ga₂O₃ with sapphire is represented as $\langle 001 \rangle \kappa$ -Ga₂O₃ || $\langle 0001 \rangle$ Al₂O₃, $\langle 010 \rangle \kappa$ -Ga₂O₃ || $\langle 11\bar{2}0 \rangle$ Al₂O₃ and $\langle 100 \rangle \kappa$ -Ga₂O₃ || $\langle 1\bar{1}00 \rangle$ Al₂O₃ [24,25].

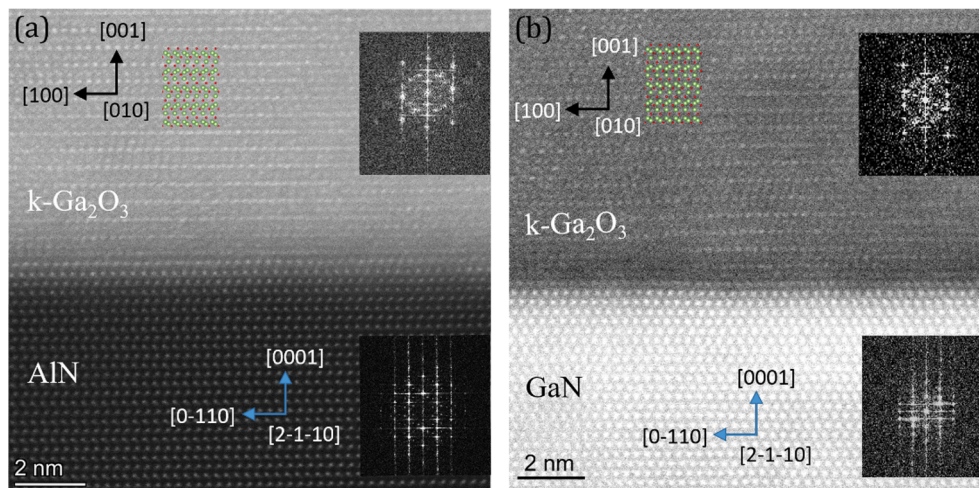


Fig. 2. HAADF-STEM images of the cross-sectional view of (a) κ -Ga₂O₃/AlN interface and (b) κ -Ga₂O₃/GaN interface, respectively. Both images are taken along the $[11\bar{2}0]$ zone axis of AlN and GaN, as shown in the inset of the corresponding FFT (a) and (b). A crystal model of κ -Ga₂O₃ along its $[010]$ zone axis is overlaid on the as-grown thin film.

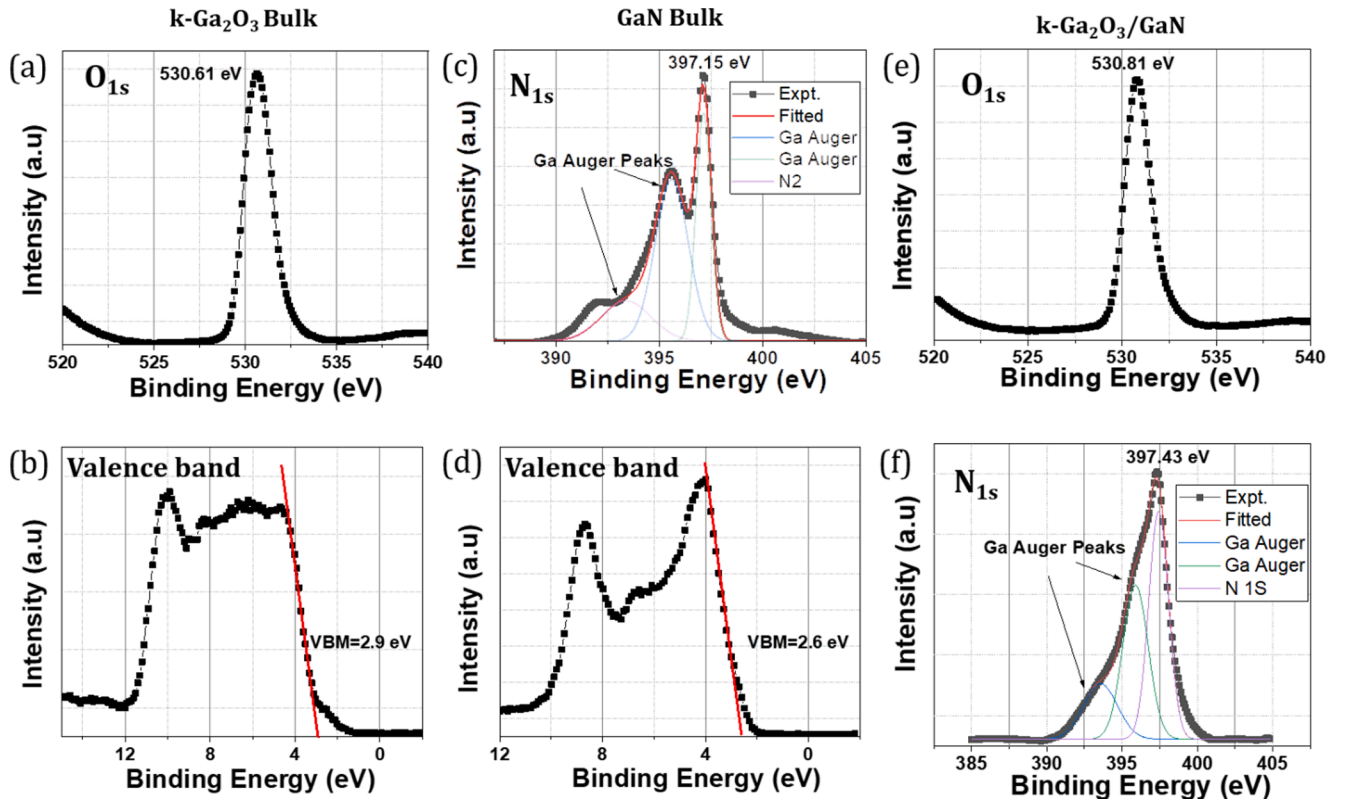


Fig. 3. XPS core level spectra of (a) O_{1s} and (b) valence band spectra of the bulk $\kappa\text{-Ga}_2\text{O}_3$; core level spectra of (c) N_{1s} and (d) valence band spectra of the bulk GaN; core level spectra of (e) O_{1s} and (f) N_{1s} of the $\kappa\text{-Ga}_2\text{O}_3/\text{GaN}$ heterostructure.

The structural properties were further cross-examined by Reflection High Energy Electron Diffraction (RHEED) and Atomic Force Microscopy (AFM). The inset of Fig. 1 represents the AFM and RHEED pattern of $\kappa\text{-Ga}_2\text{O}_3$ grown on various substrates. The bottom right inset of Fig. 1 exemplifies the corresponding growth structure schematics. A very smooth and uniform surface morphology was witnessed in the AFM images shown in top right inset for all the samples. The Root Mean Square (RMS) roughness values are 1.2 nm, 1.3 nm and 0.78 nm, respectively for the sample grown on sapphire, AlN, and GaN. The left inset represents the RHEED images along (100) and (010) azimuthal planes. A prominent streaky patterns along with 6×6 reconstruction (along (010)) were observed on $\kappa\text{-Ga}_2\text{O}_3$ grown on sapphire, AlN and GaN templates. The streaky pattern in both azimuthal images confirms the two-dimensional growth with highly single crystalline nature.

Further, the heterostructure interface quality was scrutinized by STEM. The cross-sectional STEM images of the $\kappa\text{-Ga}_2\text{O}_3/\text{AlN}$ and $\kappa\text{-Ga}_2\text{O}_3/\text{GaN}$ heterostructure are represented in the supplementary information S2. It exhibits a columnar growth of the material along (001) zone axis. Fig. 2 a) and 2b) shows the cross sectional high angle annular dark-field (HAADF) image of $\kappa\text{-Ga}_2\text{O}_3/\text{AlN}$ and $\kappa\text{-Ga}_2\text{O}_3/\text{GaN}$ heterostructure, respectively. It exemplifies a sharp interface between the heterostructure and aligned, well-ordered crystal lattice of $\kappa\text{-Ga}_2\text{O}_3$, AlN and GaN. Moreover, HR-STEM observations reveal that as-grown $\kappa\text{-Ga}_2\text{O}_3$ layer has a high crystal-quality with clear and regular atomic arrangement. The inset image represents the corresponding Fast Fourier transform (FFT) of each layer which possesses the hexagonal wurtzite features of AlN and GaN template while an orthorhombic crystal structure feature of $\kappa\text{-Ga}_2\text{O}_3$ [26]. An orthorhombic crystal model of $\kappa\text{-Ga}_2\text{O}_3$ along its [010] zone axis overlayed on the as-grown thin film is in very good match with our TEM observation, which indicates that the as-grown thin film is $\kappa\text{-Ga}_2\text{O}_3$. Therefore, their epitaxial relationships are $\langle 010 \rangle \kappa\text{-Ga}_2\text{O}_3 \parallel \langle 11\bar{2}0 \rangle \text{AlN}$ and $\langle 010 \rangle \kappa\text{-Ga}_2\text{O}_3 \parallel \langle 11\bar{2}0 \rangle \text{GaN}$, respectively. No rotation domains of $\kappa\text{-Ga}_2\text{O}_3$ are observed in this

experiment. Furthermore, the atomic sharp interface between $\kappa\text{-Ga}_2\text{O}_3$ and the corresponding substrate indicates that there is no transition layer during the thin film growth [23].

Band alignment of $\kappa\text{-Ga}_2\text{O}_3/\text{GaN}$ and $\kappa\text{-Ga}_2\text{O}_3/\text{AlN}$ heterostructures were measured by HR-XPS. The HR-XPS measurements have been performed using a Kratos Axis Ultra DLD spectrometer equipped with a monochromatic $\text{AlK}\alpha$ X-ray source ($h\nu = 1486.6$ eV) operating at 150 W, a multi-channel plate, and a delay line detector under a vacuum of $\sim 10^{-9}$ Torr. The binding energy of the C_{1s} peak (284.8 eV) was used as a standard reference. The valence band offset, VBO (ΔE_v) of $\kappa\text{-Ga}_2\text{O}_3$, and GaN can be calculated from the following formula:

$$\Delta E_v = (E_{O_{1s}}^{k-\text{Ga}_2\text{O}_3} - E_{V_{\text{BVM}}}^{k-\text{Ga}_2\text{O}_3}) - (E_{N_{1s}}^{\text{GaN}} - E_{V_{\text{BVM}}}^{\text{GaN}}) - (E_{O_{1s}}^{k-\text{Ga}_2\text{O}_3/\text{GaN}} - E_{N_{1s}}^{k-\text{Ga}_2\text{O}_3/\text{GaN}}) \quad (1)$$

$E_{O_{1s}}^{k-\text{Ga}_2\text{O}_3}$ and $E_{N_{1s}}^{\text{GaN}}$ represent the O_{1s} and N_{1s} binding energy position of bulk $\kappa\text{-Ga}_2\text{O}_3$ and GaN film, while $E_{V_{\text{BVM}}}$ denotes the valence band maximum (VBM) position of respective samples. The core level (CL) and valence band (VB) spectra of the bulk $\kappa\text{-Ga}_2\text{O}_3$ film are shown in Fig. 3 (a) and Fig. 3 (b), respectively. Fig. 3 (a) illustrates the O_{1s} CL spectrum acquired from the $\kappa\text{-Ga}_2\text{O}_3$ layer which manifests a single peak at 530.61 eV, corresponding to the Ga-O bond. Fig. 3(b) represents the valence band spectrum where VBM is estimated by linearly extrapolating the leading edge to the baseline of the respective valence band photoelectron spectrum. The VBM of the $\kappa\text{-Ga}_2\text{O}_3$ is measured to be 2.9 eV. Thereby, the separation between the CL energies of O_{1s} and VBM [$\Delta E = (E_{O_{1s}}^{k-\text{Ga}_2\text{O}_3} - E_{V_{\text{BVM}}}^{k-\text{Ga}_2\text{O}_3})$] is 527.71 eV.

To determine the term in the second bracket in Eq. (1), XPS spectra of the bulk GaN were acquired. Fig. 3 (c) and 3 (d) represent the N_{1s} CL and VB spectra of GaN. The N_{1s} spectrum is deconvoluted into three peaks to exactly calculate the binding energy position of the Ga-N bond. The first two peaks positioned at 383.4 eV and 395.55 eV correspond to Ga-Auger peaks. However, the deconvoluted third peak corresponds to the Ga-N

Table 1Fitting parameters used for VBO calculation of κ -Ga₂O₃/GaN.

Sample	State	Binding energy (eV)	Bonding	FWHM (eV)
κ -Ga ₂ O ₃	O _{1s}	530.61	Ga-O	1.7
	VBM	2.9		
GaN	N _{1s}	397.15	Ga-N	1.2
	VBM	2.6		
κ -Ga ₂ O ₃ /GaN	O _{1s}	530.81	Ga-O	1.5
	N _{1s}	397.43		

bond from the N_{1s} spectrum which is positioned at 397.15 eV. Therefore, the difference between the CL energies of N_{1s} and VBM [$\Delta E = (E_{N1s}^{GaN} - E_{VBM}^{GaN})$] is determined to be 394.55 eV. The details of the fitting parameters and binding energy positions are tabulated in Table 1. The last bracket term in Eq. (1) represents the CL separation between the O_{1s} and N_{1s} peaks from the XPS measurement of κ -Ga₂O₃/GaN heterostructure. Fig. 3(e) and 3(f) show the O_{1s} and N_{1s} CLs, which is originated from κ -Ga₂O₃/GaN heterostructure, respectively. Fig. 3(e) represents the single peak of O_{1s} positioned at 530.81 eV. Further, the N_{1s} CL spectrum of the heterostructure was deconvoluted to three peaks, and the peak corresponding to the Ga-N bond from the N_{1s} spectrum is positioned at 397.43 eV. Thereby, the energy difference between the CLs of ($E_{O1s}^{k-Ga2O3/GaN} - E_{N1s}^{k-Ga2O3/GaN}$) is 133.38 eV. Thus, the VBO is calculated to be -0.22 ± 0.07 eV (the error value is calculated by considering the fitting error and discrepancy in the repeated measurements). The conduction band offset, CBO (ΔE_C) for κ -Ga₂O₃/GaN heterostructure is determined by substituting the VBO and electronic bandgap (E_g) values of κ -Ga₂O₃ and GaN in equation (2),

$$\Delta E_C = E_g^{k-Ga2O3} - E_g^{GaN} + \Delta E_v \quad (2)$$

$E_g^{k-Ga2O3}$ and E_g^{GaN} were measured from the transmittance tauc plot, and it is calculated to be 5.0 eV and 3.44 eV, respectively

(supplementary information S3). Hence, the CBO is estimated to be 1.38

± 0.07 eV. These experimentally determined parameters are assimilated into a band alignment diagram as represented in Fig. 5, which divulges that the κ -Ga₂O₃/GaN heterostructure forms a type-I band alignment. This peculiar band alignment with high CBO and huge polarization difference of the materials could form the two dimensional electron gas (2DEG) at the interface. The dependency of polarity (Ga and N-polar) on the band alignment of κ -Ga₂O₃/GaN will be an interesting study to be carried out in the future. Further, the band alignment of κ -Ga₂O₃ with AlN WBG semiconductor is depicted below,

The valence band offset of κ -Ga₂O₃ with AlN can be calculated from the following formula:

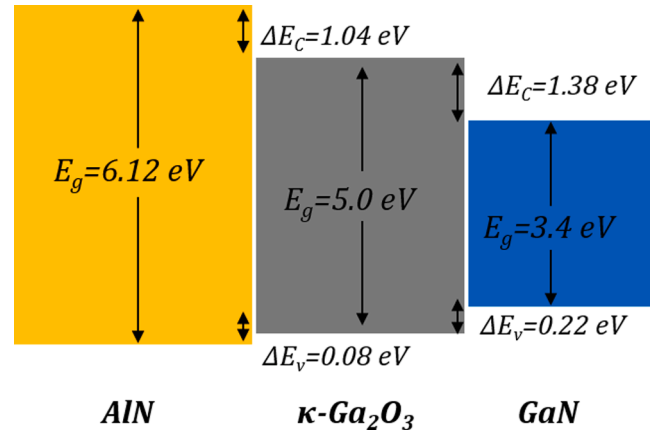


Fig. 5. The band alignment diagram of the κ -Ga₂O₃/GaN heterojunction, along with that of κ -Ga₂O₃/AlN.

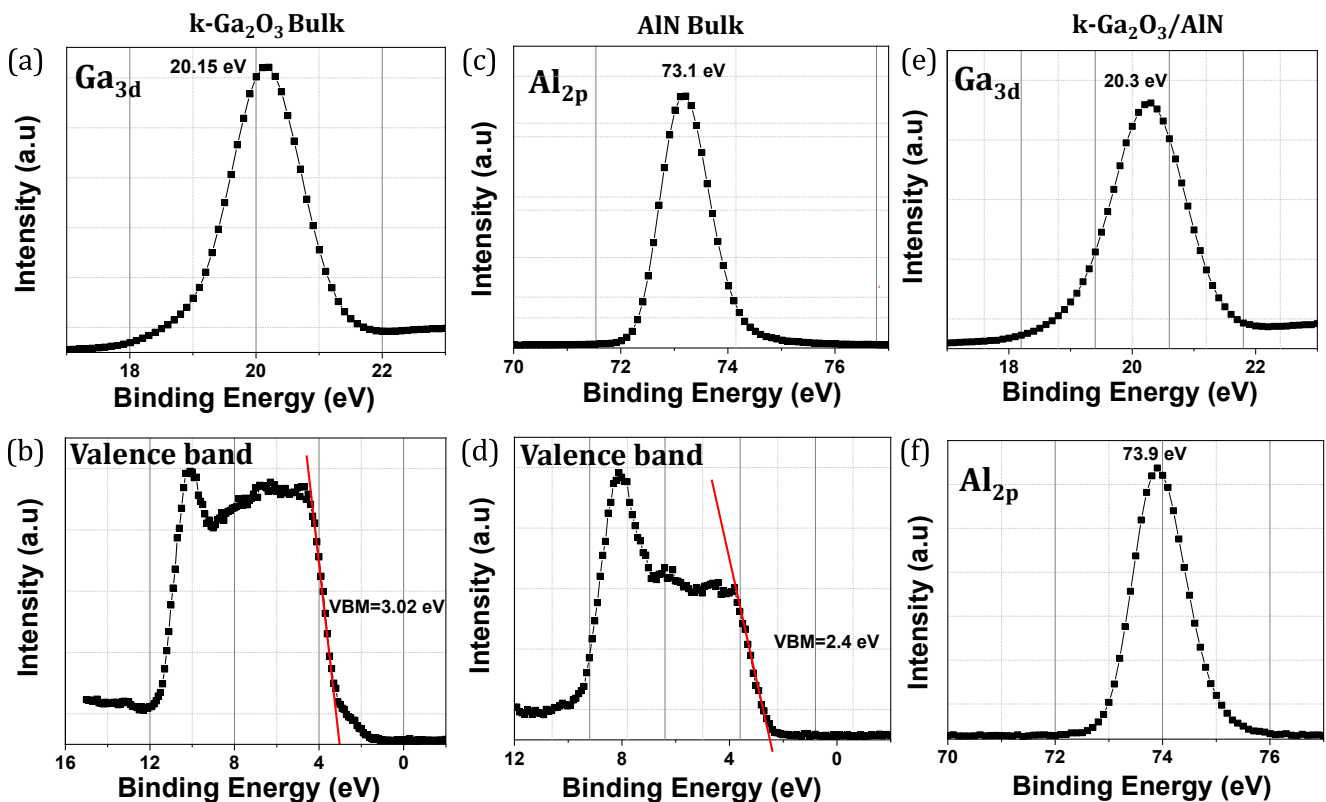


Fig. 4. XPS core level spectra of (a) Ga_{3d} and (b) valence band spectra of the κ -Ga₂O₃; core level spectra of (c) Al_{2p} and (d) valence band spectra of the AlN; core level spectra of (e) Ga_{3d} and (f) Al_{2p} of the κ -Ga₂O₃/AlN heterostructure.

Table 2Fitting parameters used for VBO calculation of κ -Ga₂O₃/AlN.

Sample	State	Binding energy (eV)	Bonding	FWHM(eV)
κ -Ga ₂ O ₃	Ga _{3d}	20.2	Ga-O	1.3
	VBM	3.02		
AlN	Al _{2p}	73.1	Al-N	0.37
	VBM	2.4		
κ -Ga ₂ O ₃ /AlN	Ga _{3d}	20.3	Ga-O	1.3
	Al _{2p}	73.9		

$$\Delta E_V = (E_{\text{Ga}3d}^{\kappa\text{-Ga}_2\text{O}_3} - E_{\text{Ga}3d}^{\kappa\text{-Ga}_2\text{O}_3}) - (E_{\text{Al}2p}^{\text{AlN}} - E_{\text{Al}2p}^{\text{AlN}}) + (E_{\text{Ga}3d}^{\kappa\text{-Ga}_2\text{O}_3/\text{AlN}} - E_{\text{Al}2p}^{\kappa\text{-Ga}_2\text{O}_3/\text{AlN}}) \quad (3)$$

$E_{\text{Ga}3d}$ and $E_{\text{Al}2p}$ represent the peak binding energy position of the Ga_{3d} and Al_{2p} CL spectra, respectively, while E_{VBM} denotes the valence band maximum position. Fig. 4 (a) and 4 (b) represent the Ga_{3d} CL and valence band spectra of κ -Ga₂O₃ bulk film. In Fig. 4 (a), Ga_{3d} binding energy is positioned at 20.15 eV with a Gaussian peak FWHM value of 1.3 eV. The valence band maximum value was evaluated to be 3.02 eV from the valence band spectra (Fig. 4 (b)). From Fig. 4 (c) and 4 (d) (for bulk AlN film), Al_{2p} position and VBM values were calculated to be 73.1 eV and 2.4 eV, respectively. These values are in good agreement with our previous report [21]. Fig. 4(e) and 4(f) show the Ga_{3d} and Al_{2p} CLs, which originated from heterostructure, respectively. The details of the fitting parameters and binding energy positions are tabulated in Table 2. Putting all these experimental values in equation (3), the VBO for κ -Ga₂O₃/AlN heterostructure is determined to be 0.08 ± 0.07 eV.

The conduction band offset (ΔE_C) for κ -Ga₂O₃/AlN heterostructure is determined by substituting the VBO and the electronic bandgap values in the equation, $\Delta E_C = E_g^{\kappa\text{-Ga}_2\text{O}_3} - E_g^{\text{AlN}} + \Delta E_V$. Thereby, CBO is calculated to be 1.04 ± 0.07 eV, where the E_g^{AlN} is measured to be 6.12 eV from the transmittance tauc plot (supplementary information S3).

Fig. 5 represents the band alignment of both κ -Ga₂O₃/GaN and κ -Ga₂O₃/AlN heterostructure, which forms a type-I band alignment. However, in our previous study, the monoclinic β -Ga₂O₃/AlN heterostructure forms a type-II band alignment with VBO of -0.55 ± 0.05 eV [21]. While the monoclinic β -Ga₂O₃/GaN heterostructure forms a type-I band alignment with a high VBO of 1.4 ± 0.08 eV [27]. This particular difference in electronic band alignment property of the same material with different phases could be utilized for various applications. In the present study, the formation of type-I is interesting for developing high electron mobility transistors for two reasons. First of all, κ -Ga₂O₃ possesses spontaneous polarisation and ferroelectric properties so that the polarization can be tuned by applying bias voltage [19]; however other phases of Ga₂O₃ do not show this unique material property. Secondly, integrating well-established nitride polarization materials with ferroelectric κ -Ga₂O₃ will allow more space for tunability of the polarization difference between the materials and thereby carrier concentration within the interface. There are a few simulation studies which explain the huge interface charges at the κ -Ga₂O₃/(Al, Ga)N interface [15,17]. Moreover, the experimental results of the band alignment study suggest that the electron affinity of κ -Ga₂O₃ will be lesser than the electron affinity of β -Ga₂O₃ ($\chi = 3.15$ eV).

4. Conclusions

In conclusion, orthorhombic Ga₂O₃ was deposited on GaN and AlN templates to form a heterojunction. XPS measurements were carried out to determine the VBO and CBO of κ -Ga₂O₃/GaN and κ -Ga₂O₃/AlN heterostructures. κ -Ga₂O₃ forms a type-I heterojunction with GaN and AlN with high CBO values of 1.38 ± 0.07 eV and 1.04 ± 0.07 eV, respectively. The existence of spontaneous polarisation property along with unique band alignment suggests the possibility of 2DCG at the hetero-interface. Therefore, this work could lead to the development of efficient power devices with tunable carrier concentrations.

CRediT authorship contribution statement

Shibin Krishna: Conceptualization, Investigation, Methodology, Data curation, Formal analysis, Writing – original draft, Writing – review & editing. **Yi Lu:** Methodology. **Che-Hao Liao:** Methodology. **Vishal Khandelwal:** . **Xiaohang Li:** Conceptualization, Investigation, Funding acquisition, Project administration, Resources, Supervision, Validation, Writing – review & editing.

Declaration of Competing Interest

The authors declare that they have no known competing financial interests or personal relationships that could have appeared to influence the work reported in this paper.

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Appendix A. Supplementary material

Supplementary data to this article can be found online at <https://doi.org/10.1016/j.apsusc.2022.153901>.

References

- [1] C.G. Van de Walle, J. Neugebauer, Universal alignment of hydrogen levels in semiconductors, insulators and solutions, *Nature* 423 (2003) 626–628.
- [2] S. Juneja, R. Pratap, R. Sharma, Semiconductor technologies for 5G implementation at millimeter wave frequencies – Design challenges and current state of work, *Engineering Science and Technology, an, International Journal* 24 (2021) 205–217.
- [3] T. Ueda, GaN power devices: current status and future challenges, *Jpn. J. Appl. Phys.* 58 (SC) (2019) SC0804, <https://doi.org/10.7567/1347-4065/ab12c9>.
- [4] D. Guo, Q. Guo, Z. Chen, Z. Wu, P. Li, W. Tang, Review of Ga₂O₃-based optoelectronic devices, *Materials Today Physics* 11 (2019) 100157, <https://doi.org/10.1016/j.mtphys.2019.100157>.
- [5] S.J. Pearton, J. Yang, P.H. Cary, F. Ren, J. Kim, M.J. Tadjer, M.A. Mastro, A review of Ga₂O₃ materials, processing, and devices, *Appl. Phys. Rev.* 5 (2018), 011301.
- [6] H. von Wenckstern, Group-III Sesquioxides: Growth Physical Properties and Devices, *Adv. Electron. Mater.* 3 (9) (2017) 1600350, <https://doi.org/10.1002/aelm.v3.910.1002/aelm.201600350>.
- [7] X. Tang, K.-H. Li, C.-H. Liao, D. Zheng, C. Liu, R. Lin, N.a. Xiao, S. Krishna, J. Tauboad, X. Li, Epitaxial growth of β -Ga₂O₃ (–201) thin film on four-fold symmetry CeO₂ (001) substrate for heterogeneous integrations, *J. Mater. Chem. C* 9 (44) (2021) 15868–15876.
- [8] X. Yang, X. Du, L. He, D.i. Wang, C. Zhao, J. Liu, J. Ma, H. Xiao, Fabrication and optoelectronic properties of Ga₂O₃/Eu epitaxial films on nanoporous GaN distributed Bragg reflectors, *J. Mater. Sci.* 55 (19) (2020) 8231–8240.
- [9] X. Yang, X. Du, J. Liu, R. Chen, D.i. Wang, Y. Le, H. Zhu, B.o. Feng, J. Ma, H. Xiao, Effects of porosity on the structural and optoelectronic properties of Er-doped Ga₂O₃ epitaxial films on etched epi-GaN/sapphire substrates, *Ceram. Int.* 47 (7) (2021) 9597–9605.
- [10] B.R. Tak, S. Kumar, A.K. Kapoor, D. Wang, X. Li, H. Sun, R. Singh, Recent advances in the growth of gallium oxide thin films employing various growth techniques—a review, *J. Phys. D Appl. Phys.* 54 (45) (2021) 453002, <https://doi.org/10.1088/1361-6463/ac1af2>.
- [11] R. Batra, H.D. Tran, B. Johnson, B. Zoellner, P.A. Maggard, J.L. Jones, G. A. Rossetti, R. Ramprasad, Search for Ferroelectric Binary Oxides: Chemical and Structural Space Exploration Guided by Group Theory and Computations, *Chem. Mater.* 32 (2020) 3823–3832.
- [12] J. Kim, D. Tahara, Y. Miura, B.G. Kim, First-principle calculations of electronic structures and polar properties of (κ , ϵ)-Ga₂O₃, *Appl. Phys. Express* 11 (2018), 061101.
- [13] J. Lee, H. Kim, L. Gautam, M. Razeghi, High Thermal Stability of κ -Ga₂O₃ Grown by MOCVD, *Crystals* 11 (4) (2021) 446, <https://doi.org/10.3390/cryst11040446>.
- [14] K. Shimada, First-principles study of crystal structure, elastic stiffness constants, piezoelectric constants, and spontaneous polarization of orthorhombicPna21-M2O3(M = Al, Ga, In, Sc, Y), *Mater. Res. Express* 5 (2018), 036502.
- [15] M.B. Maccioni, V. Fiorentini, Phase diagram and polarization of stable phases of (Ga1–xInx)2O3, *Appl. Phys. Express* 9 (2016), 041102.
- [16] K. Liu, H. Sun, F. AlQatari, W. Guo, X. Liu, J. Li, C.G. Torres Castanedo, X. Li, Wurtzite BAlN and BGaN alloys for heterointerface polarization engineering, *Appl. Phys. Lett.* 111 (22) (2017) 222106, <https://doi.org/10.1063/1.5008451>.

- [17] S. Leone, R. Fornari, M. Bosi, V. Montedoro, L. Kirste, P. Doering, F. Benkhelifa, M. Prescher, C. Manz, V. Polyakov, O. Ambacher, Epitaxial growth of GaN/Ga₂O₃ and Ga₂O₃/GaN heterostructures for novel high electron mobility transistors, *J. Cryst. Growth* 534 (2020) 125511, <https://doi.org/10.1016/j.jcrysgro.2020.125511>.
- [18] X. Xia, H. Liang, X. Geng, Y. Chen, C. Yang, Y. Liu, R. Shen, M. Xu, G. Du, Synthesis of GaN network by nitridation of hexagonal ϵ -Ga₂O₃ film, *J. Mater. Sci.: Mater. Electron.* 28 (3) (2017) 2598–2601.
- [19] F. Mezzadri, G. Calestani, F. Boschi, D. Delmonte, M. Bosi, R. Fornari, Crystal Structure and Ferroelectric Properties of ϵ -Ga₂O₃ Films Grown on (0001)-Sapphire, *Inorg. Chem.* 55 (22) (2016) 12079–12084.
- [20] S.K. Tc, G. Gupta, Band alignment and Schottky behaviour of InN/GaN heterostructure grown by low-temperature low-energy nitrogen ion bombardment, *RSC Adv.* 4 (52) (2014) 27308–27314.
- [21] H. Sun, C.G. Torres Castanedo, K. Liu, K.-H. Li, W. Guo, R. Lin, X. Liu, J. Li, X. Li, Valence and conduction band offsets of β -Ga₂O₃/AlN heterojunction, *Appl. Phys. Lett.* 111 (2017), 162105.
- [22] M. Kneiß, A. Hassa, D. Splith, C. Sturm, H. von Wenckstern, T. Schultz, N. Koch, M. Lorenz, M. Grundmann, Tin-assisted heteroepitaxial PLD-growth of κ -Ga₂O₃ thin films with high crystalline quality, *APL Mater.* 7 (2018), 022516.
- [23] M. Kracht, A. Karg, J. Schörmann, M. Weinhold, D. Zink, F. Michel, M. Rohnke, M. Schowalter, B. Gerken, A. Rosenauer, P.J. Klar, J. Janek, M. Eickhoff, Tin-Assisted Synthesis of ϵ -Ga₂O₃ by Molecular Beam Epitaxy, *Phys. Rev. Appl.* 8 (2017), 054002.
- [24] K. Matsuzaki, H. Yanagi, T. Kamiya, H. Hiramatsu, K. Nomura, M. Hirano, H. Hosono, Field-induced current modulation in epitaxial film of deep-ultraviolet transparent oxide semiconductor Ga₂O₃, *Appl. Phys. Lett.* 88 (2006), 092106.
- [25] K. Jiang, J. Tang, M.J. Cabral, A. Park, L. Gu, R.F. Davis, L.M. Porter, Layered phase composition and microstructure of κ -Ga₂O₃-dominant heteroepitaxial films grown via MOCVD, *J. Appl. Phys.* 131 (2022), 055305.
- [26] I. Cora, F. Mezzadri, F. Boschi, M. Bosi, M. Čaplovičová, G. Calestani, I. Dódoný, B. Pécz, R. Fornari, The real structure of ϵ -Ga₂O₃ and its relation to κ -phase, *CrystEngComm* 19 (2017) 1509–1516.
- [27] W. Wei, Z. Qin, S. Fan, Z. Li, K. Shi, Q. Zhu, G. Zhang, Valence band offset of β -Ga₂O₃/wurtzite GaN heterostructure measured by X-ray photoelectron spectroscopy, *Nanoscale Res. Lett.* 7 (2012) 562.